PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Micron Technology, Inc.	10/03/2008

RECEIVING PARTY DATA

Name:	Aptina Imaging Corporation		
Street Address:	c/o Citco Trustees (Cayman) Limited		
Internal Address:	Regatta Office Park, West Bay Road		
City:	Grand Cayman		
State/Country:	CAYMAN ISLANDS		
Postal Code:	Y1-1205		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12183633

CORRESPONDENCE DATA

Fax Number: (610)407-0701

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 610-407-0700

sseiler@ratnerprestia.com Email:

Correspondent Name: Jack J. Jankovitz

Address Line 1: 1235 Westlakes Drive, Suite 301

Address Line 2: RatnerPrestia

Address Line 4: Berwyn, PENNSYLVANIA 19312

NAME OF SUBMITTER: Jack J. Jankovitz

Total Attachments: 11

500801210

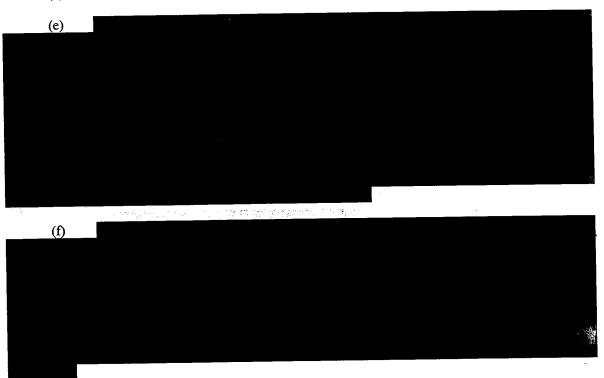
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PATENT ASSIGNMENT AGREEMENT

1. Definitions

- (a) "Agreement" shall mean this Patent Assignment Agreement.
- (b) "Assignee" shall mean **Aptina Imaging Corporation**, a Cayman Islands corporation with offices at c/o Citco Trustees (Cayman) Limited, Regatta Office Park, West Bay Road, Grand Cayman, Y1-1205, Cayman Islands.
- (c) "Assignor" shall mean **Micron Technology, Inc.**, a Delaware corporation with offices at 8000 South Federal Way, Boise, ID 83707.
 - (d) "Effective Date" shall mean October 3, 2008.

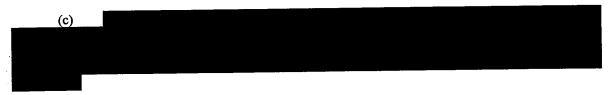


- (g) "Imaging Patents" shall mean those patents identified in ATTACHMENT "A" hereto, including, without limitation, all divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts thereof, and which may issue thereon or in connection therewith after the Effective Date of this Agreement.
- (h) "Imaging Patent Applications" shall mean those filed patent applications identified in ATTACHMENT "B" hereto, including, without limitation, all patents, divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts which may issue thereon or in connection therewith after the Effective Date of this Agreement.
- (i) "Semiconductor Patents" shall mean those patents identified in ATTACHMENT "D" hereto, including, without limitation, all divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts thereof, and which may issue thereon or in connection therewith after the Effective Date of this Agreement.

(j) "Semiconductor Patent Applications" shall mean those filed patent applications identified in ATTACHMENT "E" hereto, including, without limitation, all patents, divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts which may issue thereon or in connection therewith after the Effective Date of this Agreement.

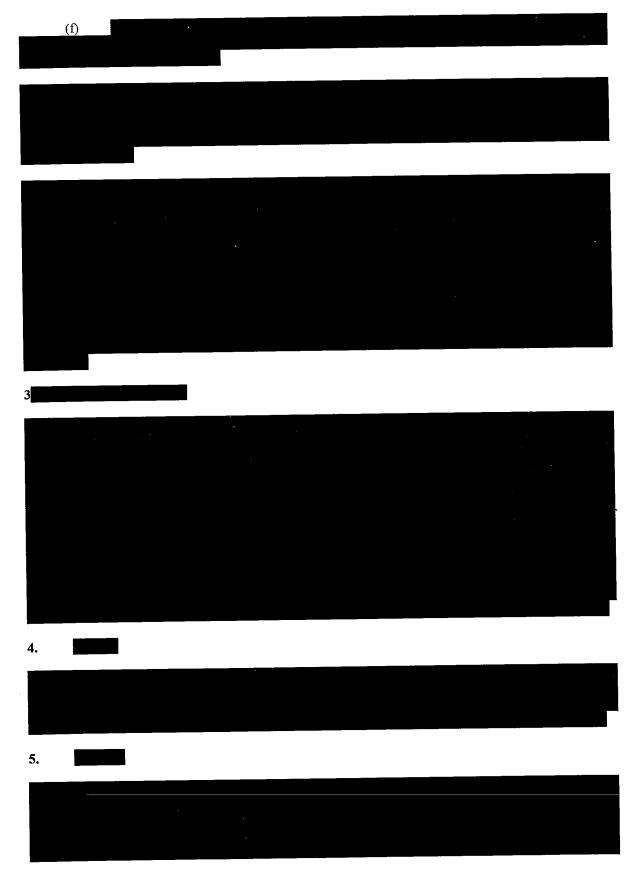


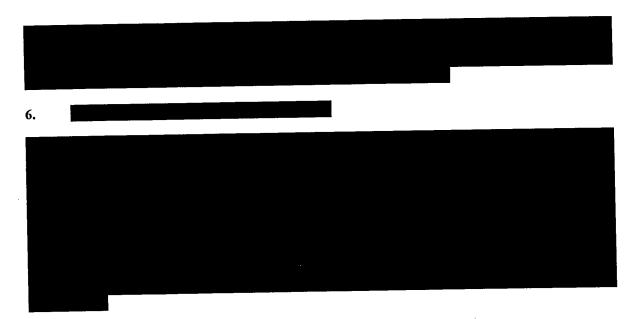
- (a) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Imaging Patents, including all rights to causes of action and remedies related thereto (including the right to sue for past, present or future infringement of rights related to the foregoing and the right to collect damages therefor). Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to issue the Imaging Patents to Assignee.
- (b) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Intellectual Property rights in the Imaging Patent Applications. Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to record assignment of the Imaging Patent Applications to Assignee.



- (d) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, and subject further to the restrictions on the Semiconductor Patents set out below, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Semiconductor Patents, including all rights to causes of action and remedies related thereto (including the right to sue for past, present or future infringement of rights related to the foregoing and the right to collect damages therefor). Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to issue the Semiconductor Patents to Assignee.
- (e) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any,

 Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Intellectual Property rights in the Semiconductor Patent Applications. Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to record assignment of the Semiconductor Patent Applications to Assignee.





7. General

This Agreement shall be effective as of the Effective Date hereof and shall be binding on the respective heirs, assigns, representatives, and successors of Assignor and of Assignee.

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	Micron Technology, Inc.
	Signed:
	Date:
Notarization State of Idaho County of Ada On 9/26/08, before me, fortary name who executed this Assignment in my presence and ack authorized capacity for the purposes set forth herein.	_, personally appeared the above-named Sking R. Applications nowledged to me that he did so of his own free will and in his
aumorized capacity for the purposes see 1912 1912	Signed:
REVIEWED MTI LEGAL	My commission expires: 8/12/11
Notarization State of Idaho County of Ada	Agreed to by: Aptina Imaging Corporation Signed: Johnson Jour J. Date: 9/26/09, 2008
On $\frac{9/26/08}{(date)}$, before me, $\frac{1}{(a)}$ (notary name)	_, personally appeared the above-named Through Llans, JV.
authorized canacity for the numoses set forth herein.	knowledged to me that he did so of his own free will and in his
A R. SOMMENTALINATION OF THE PROPERTY OF THE P	My commission expires: \(\frac{1}{12/11}\)

Agreed to by:

[Signature page to the Patent Assignment Agreement]

ATTACHMENT "A"

ATTACHMENT "B"

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Aptina Applications

FILE NUMBER	TITLE	STATUS	COUNTRY NAME	APPLICATION NUMBER	DATE FILED
AVG0-0052.00/JP	Method For Detecting And	Pending	Japan	2003324172	Sep 17, 2003
AVG0-0032.003F	Correcting Defective Pixels In A Digital Image Sensor				
AVGO-0053.00/EP	CMOS image sensor using	Pending	European Patent Office	030078067	Apr 4, 2003
	gradient index chip scale lenses	The second secon	and the second s	***************************************	Aug 13, 2003
AVGO-0053,00/JP	CMOS image sensor using gradient index chip scale lenses	Pending	J apan 3	2003793248	
AVGO-0053.00/PR	CMOS image sensor using gradient index chip scale lenses	Completed	United States of America	60403411	Aug 13, 2002
AVG0-0053:01/US	CMOS image sensor using gradient index chip scale	Pending	United States of America	12183633)Júl 31; 2008
AVGO-0054.00/JP	lenses IMAGING APPARATUS AND	Pending	Japan	2003146149	May 23, 2003
AVGO-0034.00/01	ITS MANUFACTURING	•		AND THE RESIDENCE OF THE SAME WAS	
AVGO-0055:00/US	Apparetus and method for detecting and compensating	Pending	United States of America	10388813	I Mar 14, 2003
	(or illuminant intensity change within an image	es.		V.	
AVGO-0056.01/US	Multifunction lens	Pending	United States of America	12176760	Jul 21, 2008
AVG0-0057.00/JP	WAFER SCALE MANUFACTURING METHO	L'Pénding	Japan .	2004058701	Mar 3, 2004
AVGO-0058.00/EP	System and method for shap		European Patent Office	030253033	Nov 3, 2003
• • • • • • • • • • • • • • • • • • • •	reconstruction from optical images	The state of the s			(Nov.3, 2003 as
AVG0:0058:01/EP:	System and method for shap reconstruction from optical	e Pending	European Patent Office	070016340	
	images	r Pending	Germany	1020050450776	Sep 21, 2005
AVGO-0059.00/DE	A Method And Apparatus Fo Distributed Analyses Of	r enging			
AVG0:0059.00/GB	Images A Method And Apparatus Fo	r Pending	United Kingdom	05225040	Nov 3 2005 8
	Distributed Analyses Of Images				D14 2005
AVGO-0059.00/JP	A Method And Apparatus Fo Distributed Analyses Of	r Pending	Japan	2005360643	Dec 14, 2005
AVG0-0059.01/US	Images A Melhod And Apparalus Fo	r Pending	United States of America	12138579	Jun 13, 2008
7730-00301100	Distributed Analyses Of			A salah dan salah sa	ter er statister i der der folgegeber bereicht erweit er von der er aus der fellen der er gegen für ein der de Bereichte bei der der der folgegeber der der der der der er der der der de

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ATTACHMENT "C"

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ATTACHMENT "D"

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ATTACHMENT "E"

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